

MATERIALS AND FINISHES

BODY SEE TABLE
PLATED SEE TABLE

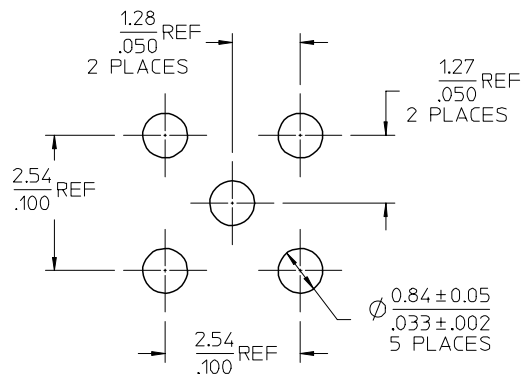
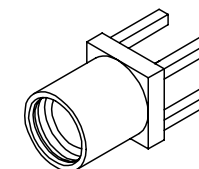
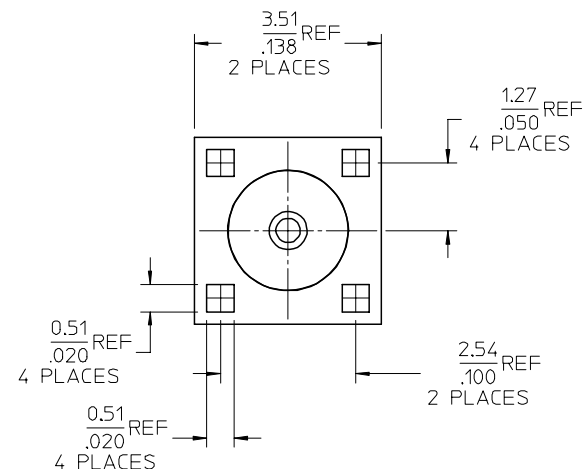
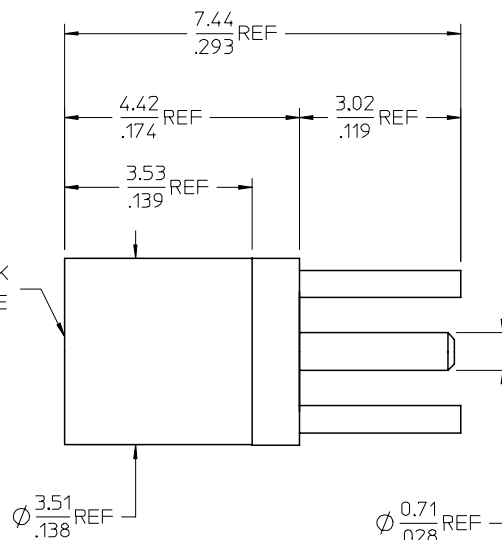
CENTER CONTACT BERYLLIUM COPPER
PLATED GOLD

INSULATOR TEFLON

NOTE
PART # 73415-1473 IS

(NON-MAGNETIC)

MMCX JACK
INTERFACE



RECOMMENDED PCB LAYOUT

73415-1474	TRAY	BRASS/GOLD(PER COMMERCIAL REQUIRMENT)
73415-1473	BULK	BeCu/GOLD (NON MAGNETIC)
73415-1472	P/N 73415-1471, ONE PER BAG	BRASS/GOLD(PER COMMERCIAL REQUIRMENT)
73415-1471	BULK	BRASS/GOLD(PER COMMERCIAL REQUIRMENT)
73415-1470	BULK	BRASS/GOLD(PER MILITARY REQUIRMENT)
PART NO.	PACKAGING	MATERIAL/PLATING

ES-73599-0000-016	INTERFACE
PS-89675-1910	ELECTRO/MECH PER.
SPECIFICATION	DESCRIPTION

CHG: ADDED P/N
73415-1474

EC NO: URF2008-0076
2007/08/09
DRAWN: CHAN05
CHKD: 2007/08/10
APPR: MHIANG
2007/08/10

QUALITY
SYMBOLS
=0
=0

GENERAL TOLERANCES (UNLESS SPECIFIED)	
mm	INCH
4 PLACES ± .005	± .0002
3 PLACES ± .005	± .0002
2 PLACES ± .005	± .0002
1 PLACE ± .005	± .0002
ANGULAR ± 2 °	
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	

DIMENSION STYLE MM/IN	
DRAWN BY	DATE
TEF	2000/01/14
CHECKED BY	DATE
TEF	2000/01/14
APPROVED BY	DATE
GMH	2000/01/14
MATERIAL NO.	
SIZE	
C	

SCALE	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
MMCX JACK, PCB MOUNT 50 OHMS, EWR-1968 MMCX-J/PCB		
MOLEX INCORPORATED		
DOCUMENT NO.	SHEET NO.	
SD-73415-147	1 OF 1	